

SURFACE MOUNT DUAL, SILICON SWITCHING DIODES



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD2836 and CMPD2838 types are ultra-high speed switching diodes manufactured by the epitaxial planar process, in an epoxy molded surface mount package, designed for high speed switching applications.



The following configurations are available:

CMPD2836 CMPD2838	DUAL, COMMON ANODE DUAL, COMMON CATHODE	MARKING CODE: CA2 MARKING CODE: CA6		
MAXIMUM RA	TINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitiv	e Reverse Voltage	V _{RRM}	75	V
Average Forward Current		Ι _Ο	200	mA
Peak Forward Current		IFM	300	mA
Power Dissipat	lion	PD	350	mW
Operating and	Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resis	tance	Θ_{JA}	357	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (TA=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _R	V _R =50V			100	nA
вv _R	Ι _R =100μΑ	75			V
VF	I _F =10mA			1.0	V
V _F	I _F =50mA			1.0	V
V _F	I _F =100mA			1.2	V
CT	V _R =0, f=1.0MHz		1.5	4.0	pF
t _{rr}	$I_{\mbox{\scriptsize R}} = I_{\mbox{\scriptsize F}} = 10 \mbox{\scriptsize mA}, \ \mbox{\scriptsize R}_{\mbox{\scriptsize L}} = 100 \mbox{\scriptsize \Omega}, \ \mbox{\scriptsize Rec.} \ \mbox{to} \ 1.0 \mbox{\scriptsize mA}$			4.0	ns

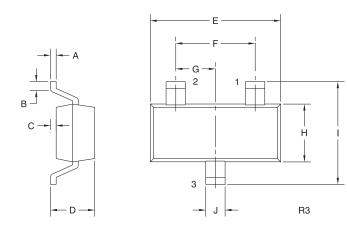
R6 (25-January 2010)





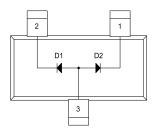
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SOT-23 CASE - MECHANICAL OUTLINE



DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
А	0.003	0.007	0.08	0.18				
В	0.006	-	0.15	-				
С	-	0.005	-	0.13				
D	0.035	0.043	0.89	1.09				
E	0.110	0.120	2.80	3.05				
F	0.075		1.90					
G	0.037		0.95					
Н	0.047	0.055	1.19	1.40				
ĺ	0.083	0.098	2.10	2.49				
J	0.014	0.020	0.35	0.50				
SOT-23 (REV: R3)								

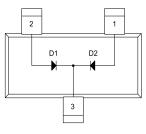
PIN CONFIGURATIONS



CMPD2836 LEAD CODE:

Cathode D2
Cathode D1
Anode D1, D2

MARKING CODE: CA2



CMPD2838

LEAD CODE: 1) Anode D2 2) Anode D1 3) Cathode D1, D2

MARKING CODE: CA6

R6 (25-January 2010)

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